

CC7A-T1A

Product Documentation

CC7A-T1A

AT-Cut Quartz Crystal Unit 20 MHz – 50 MHz

2. Product Description

The CC7A-T1A is a high frequency SMT Quartz Crystal Unit that incorporates an AT-Cut Quartz Crystal Resonator. The Quartz Crystal Resonator operates under vacuum condition in a hermetically sealed ceramic package with ceramic lid.

Suitable oscillator-circuitries can operate the CC7A-T1A Quartz Crystal Units in fundamental mode in the frequency range of 20 MHz – 50 MHz. For technical assistance for optimizing oscillator-circuitries please contact Micro Crystal under sales@microcrystal.com

2.1. Application Examples

Telemetry Optical Network Airborne Equipment Radio Communication Health Care and Medical

2.2. Ordering Information

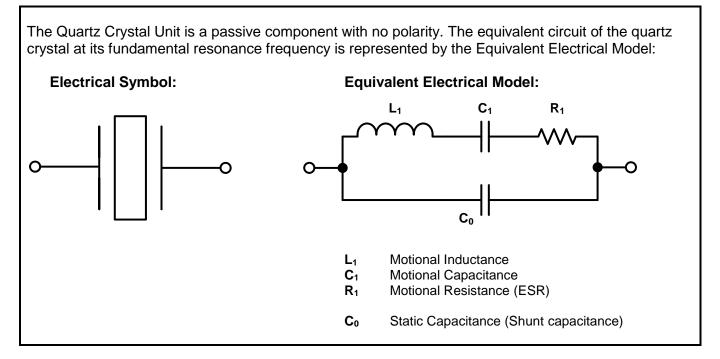
Example: CC7A-T1A 26.000 MHz CL: 9.0 pF -50/+50ppm TA QI

Code	Operating temperature range
TA (Standard)	-40 to +85°C
ТВ	-40 to +125°C
TC	-55 to +125°C
ТХ	Custom

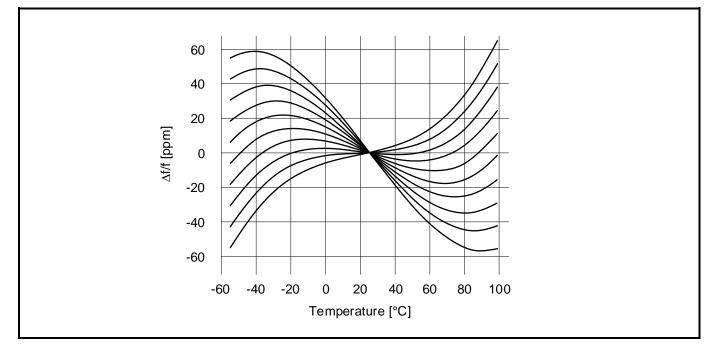
Code	Qualification
QI (Standard)	Industrial Grade
QM	Medical Grade
QS	Custom Specification

3. Electrical Characteristics

3.1. Equivalent Electrical Model

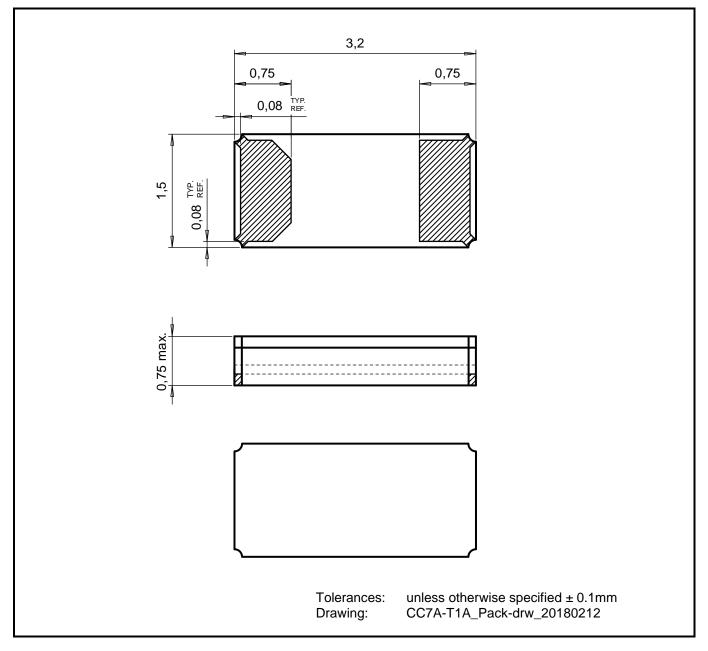


3.2. Frequency vs Temperature Characteristics

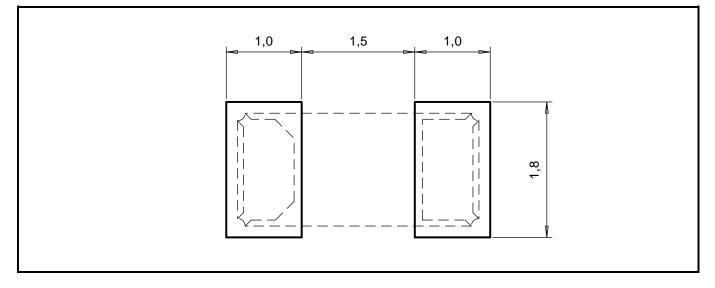


4. Mechanical Properties

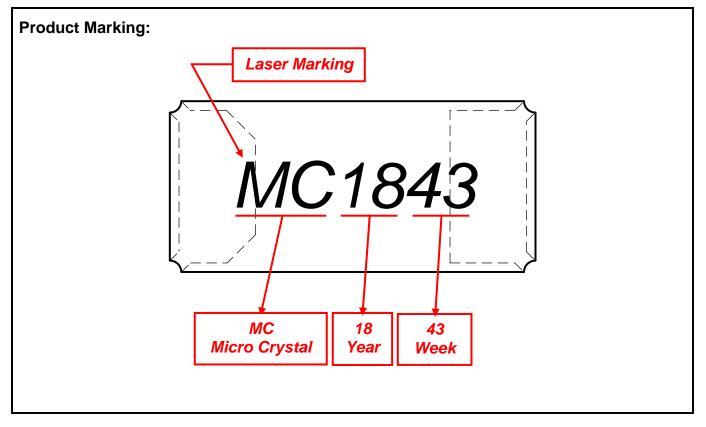
4.1. Package Dimension



4.2. Recommended Solderpad Layout



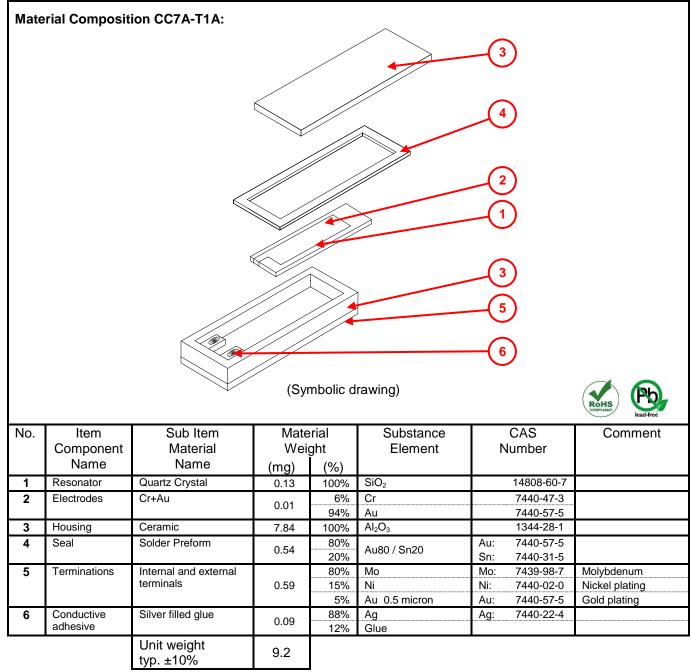
4.3. Product Marking



5. Material Composition Declaration & Environmental Information

5.1. Homogenous Material Composition Declaration

Homogenous material information according to IPC-1752 standard



CC7A-T1A

5.2. Material Analysis & Test Results

Homogenous material information according to IPC-1752 standard

No.	No. Item Sub Item Component Material		RoHS						Halogen				Phthalates			
	Name	Name	qd	Сd	бH	Cr+6	PBB	PBDE	Э	CI	Br	I	BBP	DBP	DEHP	dNIQ
1	Resonator	Quartz Crystal	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
2	Electrodes	Cr+Au	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
3	Housing	Ceramic	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
4	Seal	Solder Preform	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
5	Terminations	Int. & ext. terminals	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
6	Conductive adhesive	Silver filled glue	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
	MDL	Measurement Detection Limit	2 ppm 5 ppm			50 ppm			0.00	0.003%						

Test methods:

Test method with reference to IEC 62321-5: 2013 Test method with reference to BS EN 14582:2007 Test method with reference to EN 14372

= not detectable nd

RoHS Halogen Phthalates

MDL: 2 ppm (PBB / PBDE: 5 ppm)

MDL: 50 ppm

MDL: 0.003 % (DINP 0.01%)

5.3. Recycling Material Information

Recycling material information according to IPC-1752 standard.

Item Material	No.	Item Component	Material Weight		Substance Element		CAS mber	Comment
Name		Name	(mg)	(%)				
Quartz Crystal	1	Resonator	0.13	1.41	SiO ₂	1	4808-60-7	
Chromium	2	Electrodes	0.0006	0.007	Cr	7	440-47-3	
Ceramic	3	Housing	7.84	85.22	AI_2O_3	1	344-28-1	
Gold	2 4 5	Electrodes Seal Terminations	0.47	5.12	Au	7	440-57-5	
Tin	4	Seal	0.11	1.17	Sn	Sn: 7	440-31-5	
Nickel	5	Terminations	0.09	0.96	Ni	Ni: 7	440-02-0	
Molybdenum	5	Terminations	0.47	5.13	Мо	Mo: 7	439-98-7	
Silver	6a	Conductive adhesive	0.08	0.86	Ag	Ag: 7	440-22-4	
Glue	6b	Conductive adhesive	0.011	0.12	Glue			
	Unit v typ. ±	veight (total) :10%	9.2	100		-		

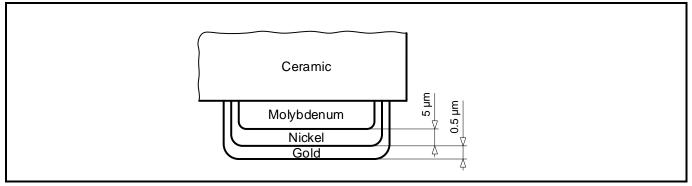
available on request

5.4. Environmental Properties & Absolute Maximum Ratings

Package	Description						
DFN-2 ceramic package	Dual Flat No Leads (DFN), hermetically sealed ceramic package with ceramic lid.						
Parameter	Directive	Conditions	Value				
Product weight (total)			9.2 mg				
Storage temperature	MIL-O-55310	Store as bare product	-55 to +125°C				
Moisture sensitivity level (MSL)	IPC/JEDEC J-STD-020D		MSL 1				

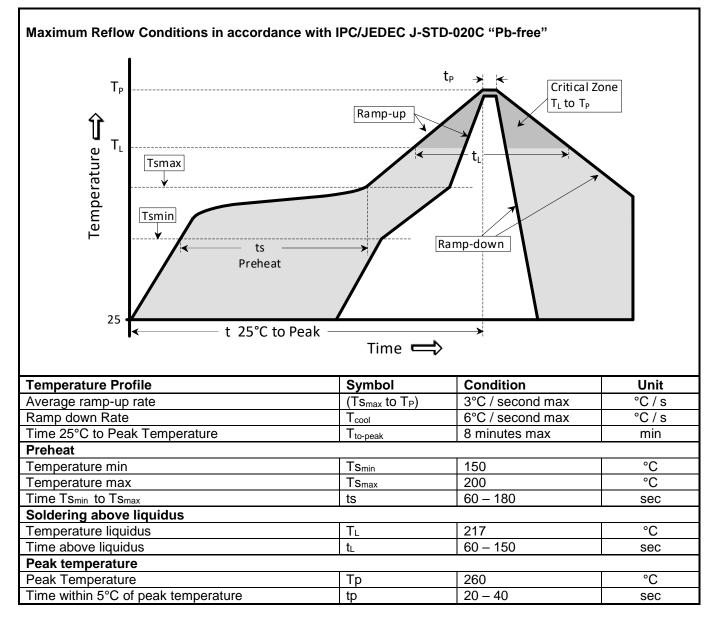
Terminal finish:

FIT / MTBF



6. Application Information

6.1. Soldering Information



6.2. Handling Instructions for Quartz Crystal Units

The built-in AT-cut crystal consists of pure Silicon Dioxide in crystalline form. The cavity inside the package is evacuated and hermetically sealed in order for the crystal blank to function undisturbed from air molecules, humidity and other influences.

Shock and vibration:

Keep the crystal / module from being exposed to **excessive mechanical shock and vibration**. Micro Crystal guarantees that the crystal / module will bear a mechanical shock of 5000 g / 0.3 ms.

The following special situations may generate either shock or vibration:

Multiple PCB panels - Usually at the end of the pick & place process the single PCBs are cut out with a router. These machines sometimes generate vibrations on the PCB that have a fundamental or harmonic frequency close to the resonance frequency of the crystal unit. This might cause breakage of crystal blanks due to resonance. Router speed should be adjusted to avoid resonant vibration.

Ultrasonic cleaning - Avoid cleaning processes using ultrasonic energy. These processes can damage the crystals due to the mechanical resonance frequencies of the crystal blank.

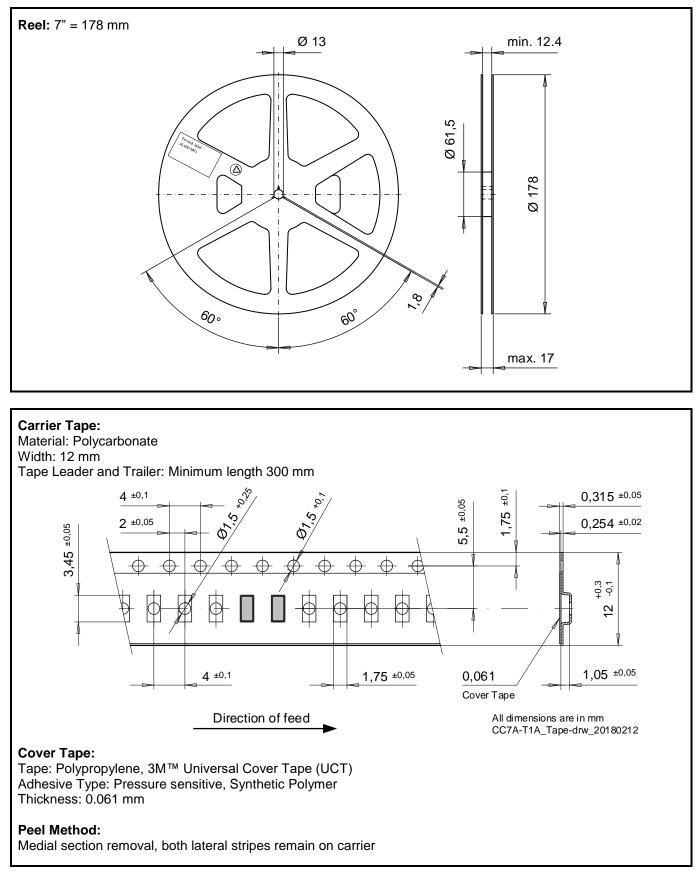
Overheating, rework high temperature exposure:

Avoid overheating the package. The package is sealed with a seal ring consisting of 80% Gold and 20% Tin. The eutectic melting temperature of this alloy is at 280°C. Heating the seal ring up to >280°C will cause melting of the metal seal which then, due to the vacuum, is sucked into the cavity forming an air duct. This happens when using hot-air-gun set at temperatures >300°C.

Use the following methods for rework:

- Use a hot-air- gun set at 270°C.
- Use 2 temperature controlled soldering irons, set at 270°C, with special-tips to contact all solder-joints from both sides of the package at the same time, remove part with tweezers when pad solder is liquid.

7. Packing & Shipping Information



8. Compliance Information

Micro Crystal confirms that the standard product Quartz Crystal Unit CC7A-T1A is compliant with "EU RoHS Directive" and "EU REACh Directives".

Please find the actual Certificate of Conformance for Environmental Regulations on our website: CoC Environment CC&CM-Series.pdf

9. Document Revision History

Date	Revision #	Revision Details
April 2018	1.0	First release
October 2018	1.1	Opened frequency range up to 20 MHz – 50 MHz.
March 2021	1.2	Adapted Application Examples, 2.1. Added package designation DFN-2, 5.4. Added new disclaimer

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Micro Crystal AG Muehlestrasse 14 CH-2540 Grenchen Switzerland

Phone +41 32 655 82 82 sales@microcrystal.com www.microcrystal.com